

FDS3812-NL-VB Datasheet N-Channel 80 V (D-S) MOSFET

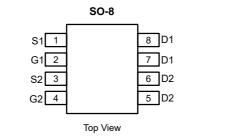
PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
80	0.062 at V _{GS} = 10 V	3.5	7.3 nC	
00			7.5110	

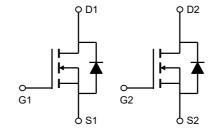
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Conversion
 - Notebook System Power





Absolute Maximum Ratings T _A =25°C unless otherwise noted					
Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	80	V	
Gate-Source Voltage		V _{GS}	±30	V	
Continuous Drain Current	T _A =25℃		3.5		
	T _A =70℃	'D	2.9	А	
Pulsed Drain Current ^C		I _{DM}	18		
Avalanche Current ^C		I _{AR}	16	А	
Repetitive avalanche energy L=0.1mH ^C		E _{AR}	12.8	mJ	
Power Dissipation ^B	T _A =25℃	D	2	W	
	T _A =70℃	PD	1.3	vv	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	Ĵ	

Thermal Characteristics					
Parameter	Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient ^A	t ≤ 10s	R _{0JA}	48	62.5	°C/W
Maximum Junction-to-Ambient AD	Steady-State	Γ _{θJA}	74	90	°C/W
Maximum Junction-to-Lead	Steady-State	$R_{ ext{ heta}JL}$	32	40	°C/W



ilable



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		80			V
I	Zero Gate Voltage Drain Current	V _{DS} =80V, V _{GS} =0V				1	μA
I _{DSS}			T _J =55℃			5	μΛ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±30V				100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250 \mu A$		3.5	4.2	5	V
I _{D(ON)}	On state drain current	V_{GS} =10V, V_{DS} =5V		18			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.5A			62		
DS(ON)	Static Drain-Source On-Resistance		T _J =125℃		113.0		mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =3.5A			15		S
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.77	1	V
ls	Maximum Body-Diode Continuous Cu	s Current				2.5	Α
I _{SM}	Pulsed Body-diode Current ^C				18	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance			510	640	770	pF
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =40V, f=	V _{GS} =0V, V _{DS} =40V, f=1MHz		40	52	pF
C _{rss}	Reverse Transfer Capacitance				20	30	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.9	1.8	2.7	Ω
SWITCHI	NG PARAMETERS	•				-	
Q _g (10V)	Total Gate Charge			8	11	13	nC
Q _g (4.5V)	Total Gate Charge	V _{GS} =10V, V _{DS} =40V, I	-3.54	4	5.5	7	
Q _{gs}	Gate Source Charge	• _{GS} -100, v _{DS} -400, 1	D-3.5A	4	5	6	nC
Q _{gd}	Gate Drain Charge	-		0.7	1.2	1.7	nC
t _{D(on)}	Turn-On DelayTime				7.2		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =40V, R_{L} =8 Ω , R_{GEN} =3 Ω			2.2		ns
t _{D(off)}	Turn-Off DelayTime				17		ns
t _f	Turn-Off Fall Time				2		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.5A, dI/dt=300A/µ	us	14	20	26	ns
Q _{rr}	Body Diode Reverse Recovery Charge	∋ I _F =3.5A, dI/dt=300A/μ	ιs	35	50	65	nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25$ °C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}=150$ °C, using ≤ 10 s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150$ °C. Ratings are based on low frequency and duty cycles to keep initial $T_{J}=25$ °C.

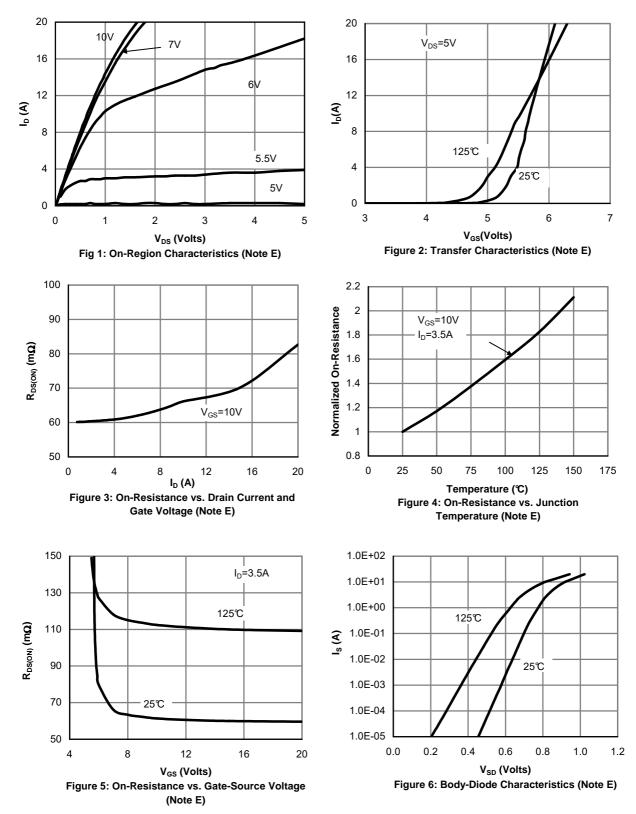
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with

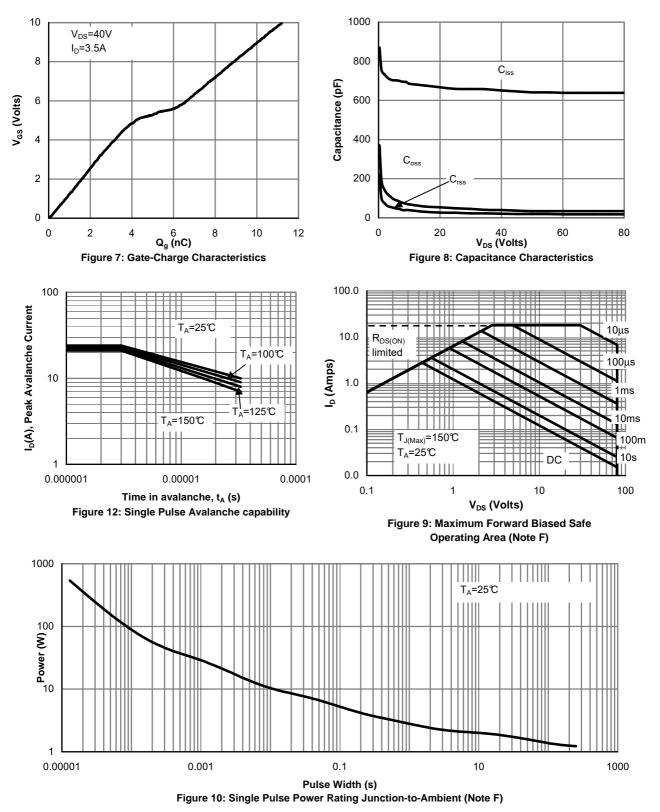


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



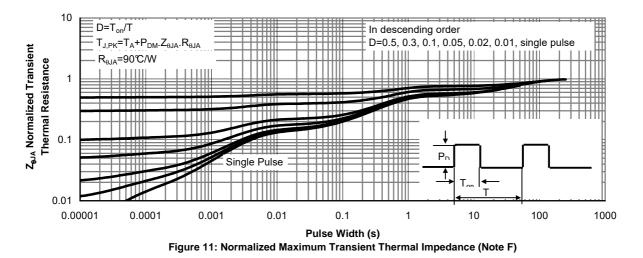


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





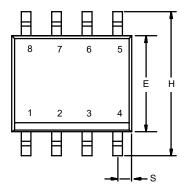
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

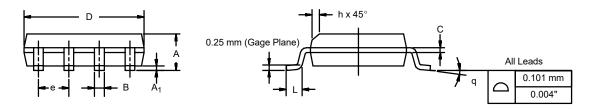




SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

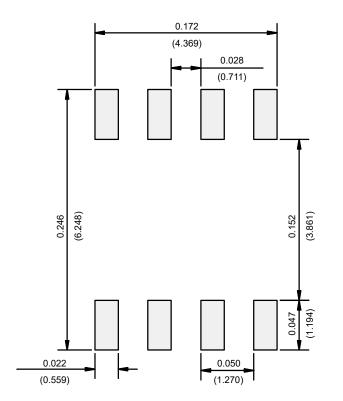




	MILLIMETERS		INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

Taiwan VBsemi Electronics Co., Ltd., branches, agents, employees, and all persons acting on its or their representatives (collectively, the "Taiwan VBsemi"), assumes no responsibility for any errors, inaccuracies or incomplete data contained in the table or any other any disclosure of any information related to the product.(www.VBsemi.com)

Taiwan VBsemi makes no guarantee, representation or warranty on the product for any particular purpose of any goods or continuous production. To the maximum extent permitted by applicable law on Taiwan VBsemi relinquished: (1) any application and all liability arising out of or use of any products; (2) any and all liability, including but not limited to special, consequential damages or incidental; (3) any and all implied warranties, including a particular purpose, non-infringement and merchantability guarantee.

Statement on certain types of applications are based on knowledge of the product is often used in a typical application of the general product VBsemi Taiwan demand that the Taiwan VBsemi of. Statement on whether the product is suitable for a particular application is non-binding. It is the customer's responsibility to verify specific product features in the products described in the specification is appropriate for use in a particular application. Parameter data sheets and technical specifications can be provided may vary depending on the application and performance over time. All operating parameters, including typical parameters must be made by customer's technical experts validated for each customer application. Product specifications do not expand or modify Taiwan VBsemi purchasing terms and conditions, including but not limited to warranty herein.

Unless expressly stated in writing, Taiwan VBsemi products are not intended for use in medical, life saving, or life sustaining applications or any other application. Wherein VBsemi product failure could lead to personal injury or death, use or sale of products used in Taiwan VBsemi such applications using client did not express their own risk. Contact your authorized Taiwan VBsemi people who are related to product design applications and other terms and conditions in writing.

The information provided in this document and the company's products without a license, express or implied, by estoppel or otherwise, to any intellectual property rights granted to the VBsemi act or document. Product names and trademarks referred to herein are trademarks of their respective representatives will be all.

Material Category Policy

Taiwan VBsemi Electronics Co., Ltd., hereby certify that all of the products are determined to be RoHS compliant and meets the definition of restrictions under Directive of the European Parliament 2011/65 / EU, 2011 Nian. 6. 8 Ri Yue restrict the use of certain hazardous substances in electrical and electronic equipment (EEE) - modification, unless otherwise specified as inconsistent.(www.VBsemi.com)

Please note that some documents may still refer to Taiwan VBsemi RoHS Directive 2002/95 / EC. We confirm that all products identified as consistent with the Directive 2002/95 / EC European Directive 2011/65 /.

Taiwan VBsemi Electronics Co., Ltd. hereby certify that all of its products comply identified as halogen-free halogen-free standards required by the JEDEC JS709A. Please note that some Taiwanese VBsemi documents still refer to the definition of IEC 61249-2-21, and we are sure that all products conform to confirm compliance with IEC 61249-2-21 standard level JS709A.